Material Gain in Polar GaInN and AlGaN Quantum Wells: How to Overcome the 'Dead' Width for Light Emitters in These QW Systems?

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Abstract—Polar GaInN and AlGaN quantum wells (QWs) are widely used in light emitting diodes and laser diodes (LDs). However, the widths of such OWs are usually limited to a few nanometers in order to ensure a sufficiently large overlap between the wave functions of the ground electron and the ground hole state. By increasing the QW width we enter the area of 'dead' width where, the overlap of the electron and hole wave functions decreases almost to zero and the luminescence efficiency drastically deteriorates. Therefore, it is assumed that wide QWs are not suitable for light emitters and very wide (8-15 nm) QWs are not considered as a promising gain medium for LDs. Hence such QWs are very rarely studied both experimentally and theoretically. In this work the material gain is calculated for Ga_{0.8}In_{0.2}N/GaN and $Al_{0.8}Ga_{0.2}N/AIN$ QWs with a width varying in the range of 2-15 nm. We observed that the material gain at fixed carrier concentration for these QWs drops to zero with the increase in the QW width and reaches negative values in the width range of \sim 4-8 nm even for high carrier concentrations, but after exceeding a certain width to \sim 8-12 nm it begins to increase rapidly and reaches the values greater than those observed for narrow QWs. This phenomenon is related to the screening of the built-in electric field by carriers, which is easier for wide QWs, and the reduction of the distance between the energy levels for electrons and holes. For the latter reason, optical transitions between higher energy states make a very significant contribution to the positive material gain.

Index Terms—Material gain, modeling, quantum wells, III-N.

I. INTRODUCTION

THE SPONTANEOUS and piezoelectric polarization in wurtzite III-nitrides is extremely large [1], [2] and therefore

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this material aspect is very important in the design of optoelectronic devices. In general, the polarization phenomena can be beneficial in many semiconductor devices because they enabled interesting physical effects, such as doping-free high electron mobility transistors [3]–[6], polarization-induced doping [7], or enhancement in the tunneling current in devices with tunnel junctions [8]–[10]. However, they are rather not considered favorable in the GaInN and AlGaN quantum wells (QWs) used in light emitting diodes (LEDs) and laser diodes (LDs).

III-Nitride LEDs and LDs had found many applications including general lighting and displays [11]–[14], and more recently UV emitters [15]-[20], for which quantum efficiency is still low [18], [20]. Due to the possibility of inactivation of the coronavirus with UV-C light, this spectral range is becoming more and more interesting for both LEDs and LDs [21]. A successful realization of electrically pumped UV LDs has been reported by a several groups [20], [22]–[27], but performances of these devices are still unsatisfactory. Important challenges for the successful realization of UV-C LDs include several aspects [20] related to *i*) the presence of high dislocation densities, *ii*) very ineffective p- and n-type conduction in Al-rich AlGaN claddings, iii) inefficient light extraction from the active region, and iv) the non-optimized active region in terms of the material gain. The last challenge relates to polarization effects. These effects are also very important for GaInN QWs, which are used in the blue-green spectral region where efficient LDs exist but there is still room to improve the performance of these LDs.

The common challenge for GaInN and AlGaN QWs is the electric field engineering. Due to the spontaneous and piezoelectric polarization in III-Nitrides and the lattice mismatch between alloys forming the QW, a strong built-in electric field is present in GaInN and AlGaN QWs. Because of this a pronounced quantum confined Stark effect is present, leading to a red-shift of the emission spectra and spatial separation of electron and hole wave functions [28]–[34]. The latter is very unwanted phenomenon in both LEDs and LDs since it causes a significant reduction of the wave function overlap. For LEDs it leads to an increase in the carrier density at a given current flow through LED because of a lower probability of carrier recombination. It causes the reduction of quantum efficiency as a growing part of the carriers recombine through the nonradiative Auger process when the carrier density increases [35]–[39]. For LDs the material gain decreases with the increase in QW width because of the

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decrease of electron-hole overlap and therefore wide QW are not considered as a promising gain medium for LDs. In the case of GaInN/GaN QWs, the higher the indium content, the larger the built-in electric field related to piezoelectric polarization, and thus the larger the separation of carrier wave functions. This is the main cause of the loss of performance of GaInN QW devices in the green spectral range [12], [40]. In general, the same trend is expected for AlGaN/AlN QWs but this QW system is less explored.

Summarizing, very thin GaInN [11] and AlGaN [22]-[26], [41]–[44] QWs are utilized in LDs since a compromise between good quantum confinement and the large electron-hole overlap is present for 1.5-2.5 nm wide QWs [45]. For wider QWs (3-6 nm) low efficiency of emission is observed and therefore they are rarely used in LDs. 8-12 nm wide QWs (i.e., QW widths typical for LDs with non-polar QWs, i.e., GaAs-, InP-, and GaSb-based LDs [46]-[49]) are almost unexplored since it is usually assumed that such QWs will be worse for LDs applications that 3-6 nm wide QWs. However, it has recently been shown that wide GaInN QWs show unexpectedly strong photoluminescence under high excitation conditions [50] and LDs with such QWs work very well [51]. Therefore, it is a very interesting issue to carefully study material gain for GaInN and AlGaN over a wide range of widths. So far, gain calculations have been reported for GaInN and AlGaN QWs in several articles [45], [52]-[59], but for wide QWs such calculations have not been reported in these articles. The widest QWs, for which optical gain calculations have been reported so far, are the 9 nm AlGaN wells [60]. Therefore this is still unexplored area for polar QWs and this area is the subject of this article. We show that the material gain for polar GaInN/GaN and AlGaN/AlN QWs changes very unusually with the increase in QW width. A positive material gain disappears with the increase in QW width and appears again for 8-12 nm wide QWs due to the screening of the built-in electric field by carriers and the reduction of the distance between electron (hole) levels. It shows that due to the spontaneous and piezoelectric polarization in III-nitrides, the optimal QW width for applications in LDs is very unintuitive and very different from what is assumed to be optimal for non-polar QWs.

II. THEORETICAL APPROACH

The electronic band structure of GaInN/GaN and AlGaN/AlN QWs is calculated using kp Hamiltonian, which is given in details in Ref. [45]. The interaction between the CB and the VB is neglected because of the large band gap of GaInN and AlGaN, i.e., the calculation problem is reduced to the effective-mass Hamiltonian for the CB and the 6-band kp Hamiltonian for the VB. The Hamiltonian for VB is consistent with that used by other authors [52]–[54], [56], [61]–[63].

The band gap of GaInN and AlGaN is calculated using the parabolic formula with the bowing parameter of 1.7 and 0.7 eV, respectively [64]. The valence band offset (VBO) between GaInN (AlGaN) and GaN (AlN) is defined for unstrained materials, see Ref. [45]. A linear interpolation is used to obtain the valence band position in ternary alloys (GaInN and AlGaN) with

the VBO for binary compounds (InN, GaN and AlN) taken from Ref. [64].

The influence of the compressive strain in GaInN and AlGaN layer on the electronic band structure in these alloys is calculated according to the Bir-Pikus model [65], details can be found in Ref. [45].

The electric field in the GaInN (AlGaN) QW and GaN (AlN) barriers is calculated according to periodic boundary conditions [30] (1)

$$F_n = \frac{\sum_q \frac{l_q P_q}{\varepsilon_q} - P_n \sum_q \frac{l_q}{\varepsilon_q}}{\varepsilon_n \sum_q \frac{l_q}{\varepsilon_q}}$$
(1)

where the sum runs over all the layers. ε_q , P_q , and l_q are the dielectric permittivity, total polarization, and width of the *q*-th layer, respectively. A QW with this electric field is the starting point in the self-consistent solution of the Schrödinger and Poisson equations [45]. The well-known Newton-Rhapson method was used to solve the Poisson equation and plane wave expansion methods were used to diagonalize the *kp* Hamiltonian. The total polarization is given by (2)

$$P_n = P_n^S + P_n^P, (2)$$

where P_n^{S} and P_n^{P} mean the spontaneous and piezoelectric polarization in *n*-th layer, respectively. The piezoelectric polarization was calculated using (3).

$$P^{p} = \left(e_{31} - e_{33}\frac{c_{13}}{c_{33}}\right) \ (\in_{xx} + \in_{yy}) \tag{3}$$

 c_{13} and c_{33} are the elastic constants, ϵ_{xx} and ϵ_{yy} are strains defined as: $\epsilon_{xx} = \epsilon_{yy} = (a_0 - a)/a$, where a_0 and a are the lattice constants of the GaN (AlN) substrate and the GaInN (AlGaN) layer, respectively.

The piezoelectric tensor components (e_{31} and e_{33}), elastic constants (c_{13} and c_{33}), and other material parameters in GaInN and AlGaN alloys are determined using the linear interpolation of the binary parameters. Parameters of binary semiconductors used in our calculations are taken from the review paper on material parameters in III-N [64]. In recent years, some parameters have been updated [66] but they do not change much, so we decided to take the material parameters from one source for this study, with the exception of the parameters needed for the calculation of the polarization effects, which were carefully analyzed in Refs. [66], [67] and are taken into our calculations from [67].

The material gain for GaInN and AlGaN QWs is calculated for a given carrier density in QW region. This density in the CB and VB is calculated by the integration of product of the occupation probability of carriers (i.e., the Fermi-Dirac distribution) and the density of states, $\rho(k)$, over the entire band. The Fermi-Dirac distribution for electrons (f_{CB}) and holes (f_{VB}) in the QW is given by (4) and (5)

$$f_{CB} \left(E_{CB} \left(k \right), E_{CB}^{F} \right) = \left(1 + \exp\left(\frac{E_{CB} \left(k \right) - E_{CB}^{F}}{k_{B}T} \right) \right)^{-1},$$
(4)

$$f_{VB} \left(E_{CB} \left(k \right), E_{CB}^{F} \right) = \left(1 + \exp\left(\frac{E_{VB} \left(k \right) - E_{VB}^{F}}{k_{B}T} \right) \right)^{-1},$$
(5)

where k_B is the Boltzmann's constant and *T* is the temperature. Note that the carrier density determines the quasi-Fermi levels E_{CB}^F and E_{VB}^F for the CB and VB, respectively, and vice versa. The carrier density in conduction (*N*) and valence (*P*) band is calculated according to (6) and (7)

$$N = \sum_{n_{CB}} \int_{0}^{k_{max}} \rho(k) f_{CB} \left(E_{n_{CB}}(k), E_{CB}^{F} \right) dk$$
(6)

$$P = \sum_{n_{VB}} \int_{0}^{k_{max}} \rho(k) \left[1 - f_{VB} \left(E_{n_{VB}} \left(k \right), E_{VB}^{F} \right) \right] dk \quad (7)$$

The integration is carried out in k space with the density of states taken from kp calculations. k_{max} is the integration limit determined by convergence of integrals given by (6) and (7). The average carrier density is the input parameter that determines the position of the quasi-Fermi levels. Calculations are performed with a set number of levels in the conduction and valence band, i.e., 10 levels in CB and 20 levels in VB. The level that is considered bound in the QW is counted differently from the level that came out of it. In fact, the number of carriers in QW corresponding to the two-dimensional sheet density and three-dimensional conditions is calculated to correspond to the nominal value of average carrier density.

In this approximation the TE and TM mode of the material gain is given by (9):

$$g_{\beta_{\text{TE}(\text{TM})}} (\hbar \omega)$$

$$= C_0 \beta^{-1} \sum_{n_{CB}, n_{VB}} \int dk \left(f_{n_{CB}} \left(k \right) \right)$$

$$- f_{n_{VB}} (k) \sum_{i,j} |M|^2_{iCB-jHH_{\text{TE}(\text{TM})}} L \left(n_{CB}, n_{VB}, k \right)$$
(8)

where $C_0 = q^2/(\omega m_0^2 \tau_b c \varepsilon_0)$ (*q*-elementary charge; ω – angular frequency, m_o – electron mass; τ_b – broadening time; c – speed of light; ε_0 – dielectric constant), *i* and *j* represents, respectively, the electron and hole subbands, β in this case is the propagation constant of the TE (TM) mode, $|M|^2_{iCB-jVB_{\text{TE(TM)}}}$ is the matrix element of TE (TM) mode, see details in Ref. [45]. This is a method based on the relaxation time approximation convoluted with a Lorentzian function given by (8)

$$L (n_{CB}, n_{VB}, k) = \frac{\hbar/\tau_b}{\Delta(n_{CB}, n_{VB}, k)^2 + (\hbar/\tau_b)^2}, \quad (9)$$

where Δ is the proper energy difference and \hbar is the Planck constant divided by 2π . The broadening time $\tau_b = 0.1$ ps [45] is applied in our calculations to obtain the material gain spectra.

Our calculations do not take into account the inhomogeneous broadening and the excitonic effects. Typically, the excitonic effects are ignored in the gain calculations, but inhomogeneous broadening can be taken into account [60]. In this case, it is worth noting that this broadening can vary significantly with QW width



Fig. 1. Layer sequences in (a) $Ga_{0.8}In_{0.2}N(d)/GaN$ and (b) $Al_{0.8}Ga_{0.2}N(d)/AlN$ QWs together with the critical thickness for $Ga_{1-x}In_xN$ strained on GaN and $Al_{1-x}Ga_xN$ strained on AlN.

0.0

0.2 0.4 0.6 0.8

Gallium concentration (x)

0 **-**0.0

0.2 0.4 0.6 0.8 1.0

Indium concentration (x)

due to the different sensitivity to interface roughness. Therefore, for this study, the choice of the same Lorentzian broadening is a compromise solution that does not affect the final conclusions.

Fig. 1 shows the sketch of $Ga_{0.8}In_{0.2}N/GaN$ and $Al_{0.8}Ga_{0.2}N/AlN$ QWs of different width *d*, which are considered in this work. In addition, the critical thickness for $Ga_{1-x}In_xN$ ($Al_{1-x}Ga_xN$) layer grown on GaN (AlN) substrate is calculated according to Fisher's formula [68] and plotted in this figure.

In our calculations the QW width was varied from 2 to 15 nm, which is well below the critical thickness in the case of a single QW and also below the critical thickness in the case of multiple QWs if their number is properly low.

III. RESULTS AND DISCUSSION

Fig. 2 shows spectra of the TE mode of material gain calculated for Ga_{0.8}In_{0.2}N/GaN QWs of different widths at two carrier concentrations, i.e., 1.5 and 2.0×10^{19} cm⁻³. The same three-dimensional carrier concentrations were chosen for this comparison, this concentration can be compared with the current that flows through the QW located in the p-n junction, since the laser output power is usually measured as a function of current [16], [17], [24], [26]. In general, the selected carrier concentrations in QW region are quite high and a positive material gain appears at much lower carrier concentrations for thin and wide QWs, but higher carrier concentrations are better to study changes in spectral position of the material gain and its intensity. It is clearly visible that as the width of QW increases, the gain peak shifts towards longer wavelengths and its intensity decreases, reaching negative values for the width of \sim 6-7 nm. A further increase in the OW width causes the appearance of a positive gain peak, its shift towards shorter waves and an increase in its intensity. The blue shift of gain peak is observed up to a width of ~ 10 nm, and a further increase in QW width does not significantly affect the peak position. The changes observed in the material gain spectra can be explained by the screening of the electric field in the analyzed QWs.



Fig. 2. TE mode of material gain for Ga_{0.8}In_{0.2}N(d)/GaN QWs of different width at carrier concentration of 1.5 and 2.0 × 10¹⁹ cm⁻³. The QW width is changing from 2 to 15 nm. The two-dimensional concentration of carriers in QW going from top to bottom is as follows: 3.0, 4.5, 6.0, 7.5, 9.0, 10.5, 12.0, 13.5, 15.0, 16.5, 18.0, 19.5, 21.0, 22.5 ×10¹² cm⁻² for the three-dimensional carrier concentration of 1.5×10^{19} cm⁻³ and 4.0, 6.0, 8.0, 10.0, 12.0, 14.0, 16.0, 18.0, 20.0, 22.0, 24.0, 26.0, 28.0, 30.0 ×10¹² cm⁻² for the three-dimensional carrier concentration of 2.0×10^{19} cm⁻³.

Fig. 3 shows the confinement potential for Ga_{0.8}In_{0.2}N/GaN QWs of different widths (2, 7, and 15 nm) under different carrier concentrations. The quasi Fermi-levels for electrons and holes are plotted in Fig. 3 as horizontal dashed lines and the energy scale is set to zero in this figure at the hole quasi Fermi-level. The color map corresponds to the carrier distribution depending on the location and energy. The appropriate colors correspond to different values of carrier concentration. When the local concentration is summed after energy and integrated at a distance and finally divided by the QW width, the nominal value of average carrier concentration is obtained. The distribution of concentration shows how the levels are occupied and how they are responsible for screening the electric field.

The total polarization discontinuity at interfaces in these QWs is 0.036 C/m², which corresponds to the sheet concentration of 2.3×10^{13} cm⁻². Comparing this concentration with the concentration of the two-dimensional carriers in QW, see the values given in the figure caption in Fig. 3, it is clear that the screening of the built-in electric field occurs when the concentration of the 2D carriers begins to be comparable to the sheet concentration. For narrow QWs the electron-hole overlap (γ) for the fundamental transition is significant even for low



Fig. 3. The quantum confinement potential for (a) 2 nm, (b) 7 nm, and (c) 15 nm wide $Ga_{0.8}In_{0.2}N/GaN$ QWs obtained for different carrier concentrations in QW region. γ is the electron-hole overlap for the fundamental transition. FL_e and FL_h corresponds to the quasi Fermi level for electrons and holes, respectively. The color map shows the local carrier concentration at the appropriate energy levels. The total polarization discontinuity at the $Ga_{0.8}In_{0.2}N/GaN$ interface is 0.036 C/m² (it corresponds to the sheet concentration of 2.3×10^{13} cm⁻²) and do not change with the QW width, while the redistribution of carriers within QWs of different width varies very significantly. The two-dimensional concentration of carriers in QW is as follows: (a) 1.0, 3.0, 4.0×10^{12} cm⁻²; (b) 3.5, 10.5, 14.0 $\times 10^{12}$ cm⁻²; (c) 7.5, 22.5, 30.0×10^{12} cm⁻².

carrier concentration and does not change significantly with the increase in carrier concentration, see Fig. 3(a) for 2 nm wide $Ga_{0.8}In_{0.2}N/GaN$ QW. In this case electrons and holes are not able to separate in the growth direction and screen the built-in electric field. However such conditions are favorable for light emission since the electron-hole overlap is large in broad range of carrier concentrations. Therefore, the material gain is positive even for low carrier concentration in the QW region as will be shown in the next part of this paper.

For 7 nm wide QW the carrier separation in the growth direction is very large and the electron-hole overlap for the ground state transition is close to zero. With the increase in carrier concentration the electron-hole overlap does not increase significantly, see the γ parameter in Fig. 3(b). It explain why a positive material gain is not observed for this QW even if the quasi Fermi-level for electrons and holes is above the ground level. It is worth commenting here that in the case of electrons this level is much above the ground state than in the case of holes due to the lower effective mass for electrons.

The results for the 7 nm wide QW may not be promising in studies of wider QW, but as already shown in Fig. 2, a positive material gain is unexpectedly observed for wider QWs. This phenomenon can be easily understood by analyzing the confinement potential profile for a 15 nm wide Ga_{0.8}In_{0.2}N/GaN QW presented in Fig. 3(c). At low carrier concentration the electron-hole overlap is very small because of very strong carrier separation along the growth direction. However with the increase in carrier concentration in QW region the built-in electric field is screened and the electron-hole overlap for the ground state transition increases rapidly and may be greater than that observed for narrow QWs. Therefore, a broad positive gain peak is observed for wide QWs. The large broadening of the material gain peak results from the contribution of optical transitions between the excited states, which are separated by low energy due to the large width of this OW.

An important effect observed in Fig. 2 that is worth discussing again is the shift of the gain peak with the change of QW width. The redshift of this peak with an increase in QW width from 2 to 5 nm is a well-known quantum confinement Stark effect, while the blueshift observed with a further increase in QW width from 8 to 10 nm is due to the screening of built-in electric field. The wider QWs are already screened and therefore no shift in the gain peak is observed for these QW. The red and blue shift of the gain peak depend on the average carrier density in QW region (compare green and blue peaks in Fig. 2) and this phenomenon is related to both the screening of built-in electric field and the contribution of optical transitions between excited states to the gain peak.

The positive material gain observed for wide QW makes them very interesting for LD applications. Therefore, it is interesting to compare the material gain at different carrier concentrations for QWs of different width. Gain spectra for 2 and 12 nm wide Ga_{0.8}In_{0.2}N/GaN QWs obtained for different average density in QW region are shown in Fig. 4(a) and (b), respectively. The broadening of gain peak is much larger for the wider QW due to the contribution of optical transitions between excited states. The gain intensity versus the carrier concentration is shown in Fig. 4(c). In this case it is clearly visible that for the wider QW the positive material gain appears at a lower transparency carrier concentration (n_{tr}) , see arrows in Fig. 4(c), which can be directly compared with the threshold carrier concentration (n_{th}) for laser structures of the same losses on mirrors etc. This observation is in agreement with the recent experimental study for GaInN LDs [51], where lower n_{th} was observed for wider QWs. In general, this is a very interesting observation, which can strongly motivate growers to use wide QWs as the active region in LDs. The growth of such QWs can be a problem in the case of highly strained QWs for which the critical thickness is very small, but in the case of QWs with low strains the QW width can be extended up to 15 nm without any problems.

 $Al_{0.8}Ga_{0.2}N/AlN$ is the material system with smaller strains comparing to $Ga_{0.8}In_{0.2}N/GaN$ system because of smaller lattice mismatch between GaN and AlN. Therefore, it is interesting to perform a very similar analysis for $Al_{0.8}Ga_{0.2}N/AlN$ QW of different width, especially as it is an interesting gain medium



Fig. 4. Spectra of TE material gain obtained for different carrier concentrations in QW region for (a) 2 nm and (b) 12 nm wide $Ga_{0.8}In_{0.2}N/GaN$ QWs together with (c) the comparison of the peak intensity of the material gain for the two QWs of different width.

for UV LDs. Currently large area AlN substrates with the threading dislocation densities of $\sim 10^3$ cm² are available [69] and optically pumped AlGaN QW lasers emitting in deep UV can be fabricated on such substrates [70]–[74].

Fig. 5 shows spectra of the TM mode of the material gain calculated for $Al_{0.8}Ga_{0.2}N/AIN$ QWs of different widths at the carrier concentrations of 2.5 and 3.0×10^{19} cm⁻³. In contrast to the Ga_{0.8}In_{0.2}N/GaN QW, the fundamental transition in this QW is with TM polarization [59] and therefore the TM mode of the material gain is plotted in this figure. The change in the spectral position and the intensity of gain peak is very similar to that observed for Ga_{0.8}In_{0.2}N/GaN QW. The observed quantitative differences result mainly from different energy gaps, different polarization discontinuities (i.e., built-in electric field) and different effective masses for these two QW systems. The most interesting is to analyze the difference in the built-in electric field since it is the driving force for the unusual behavior of the material gain in these QWs.

Fig. 6 shows the confinement potential for Al_{0.8}Ga_{0.2}N/AlN QWs of different widths (2, 7, and 15 nm) under different carrier concentrations in QW region. Comparing to Ga_{0.8}In_{0.2}N/GaN QW the built-in electric field is smaller due to smaller polarization discontinuity at the interface of Al_{0.8}Ga_{0.2}N and AlN. However, despite the smaller built-in electric fields, the behavior of the confinement potential is similar to that observed for Ga_{0.8}In_{0.2}N/GaN QWs. For narrow QWs, the built-in electric field cannot be fully screened, but this does not drastically affect the overlapping of the wave functions for the fundamental transition (γ is changing from 0.084 to 0.26). An increase in the QW width causes a spatial separation of electrons and holes



Fig. 5. TM mode of material gain for Al_{0.8}Ga_{0.2}N(d)/GaN QWs of different width at carrier concentration in QW region of 2.5 and 3.0×10^{19} cm⁻³. The QW width is changing from 2 to 15 nm. The two-dimensional concentration of carriers in QW going from top to bottom is as follows: 5.0, 7.5, 10.0, 12.5, 15.0, 17.5, 20.0, 22.5, 25.0, 27.5, 30.0, 32.5, 35.0, 37.5 $\times 10^{12}$ cm⁻² for the three-dimensional carrier concentration of 2.5×10^{19} cm⁻³ and 6.0, 9.0, 12.0, 15.0, 18.0, 21.0, 24.0, 27.0, 30.0, 33.0, 36.0, 39.0, 42.0, 45.0 $\times 10^{12}$ cm⁻² for the three-dimensional carrier concentration of 3.0×10^{19} cm⁻³.

along the growth direction and a decrease in the overlap of the wave functions for electrons and holes. The increase in carrier concentration does not help to screen the built-in electric field when the QW width is below 10 nm. Only when the QW width is greater, the screening of built-in electric field is observed and the overlap of the wave functions for the fundamental transition is large enough.

Fig. 7(a) and (b) show gain spectra for 2 and 15 nm wide Al_{0.8}Ga_{0.2}N(d)/AlN QWs obtained for different carrier concentrations in QW region. The gain intensity versus the carrier concentration for the two QWs is shown in Fig. 7(c). As for Ga_{0.8}In_{0.2}N/GaN QWs, it is clearly visible the broadening of gain peak is much larger for the wider QW due to the contribution of optical transitions between excited states, but the positive material gain appears at lower threshold carrier concentration for the narrow QW. For the wide QW, positive material gain appears at higher n_{tr} but grows much faster and is greater than that for narrow QW at carrier concentrations greater than $\sim 2.7 \times 10^{19}$ cm⁻³. For this narrow QW, the material gain saturates at a concentration of $\sim 2.7 \times 10^{19}$ cm⁻³ and does not increase for higher concentrations of carriers in QW. Therefore, we can



Fig. 6. The quantum confinement potential for (a) 2 nm, (b) 7 nm, and (c) 15 nm wide Ala_{0.8}Ga_{0.2}N/AlN QWs obtained for different carrier concentrations in QW region. γ is the electron-hole overlap for the fundamental transition. FL_e and FL_h corresponds to the quasi Fermi level for electrons and holes, respectively. The color map shows the local carrier concentration at the appropriate energy levels. The total polarization discontinuity at the Ala_{0.8}Ga_{0.2}N/AlN interface is 0.017 C/m² (it corresponds to the sheet concentration of 1.1×10^{13} cm⁻²) and do not change with the QW width, while the redistribution of carriers within QWs of different width varies very significantly. The two-dimensional concentration of carriers in QW is as follows: (a) 1.0, 5.0, 6.0×10^{12} cm⁻²; (b) 3.5, 17.5, 21.0 $\times 10^{12}$ cm⁻²; (c) 7.5, 37.5, 45.0 $\times 10^{12}$ cm⁻².

conclude that the growth of 15 nm wide $Al_{0.8}Ga_{0.2}N(d)/AlN$ QWs can be very favorable for LDs.

The use of both narrow and wide $Al_{0.8}Ga_{0.2}N/AlN$ QWs in electrically pumped LDs is a challenge due to the difficulties in obtaining highly conductive AlN layers [20]. It will certainly be easier for QWs with higher gallium concentration in the well and the barrier. Such QWs are not considered in this article because of the simplicity of the message to show that for polar QWs there is a certain width of the QW (the so-called 'dead' width), for which it is very difficult to obtain positive material gain. However similar effects are expected for $Al_{1-x}Ga_xN/Al_{1-y}Ga_yN$ QWs, which are more promising in electrically pumped UV LDs.

Fig. 8 shows a comparison of the gain intensity versus the QW width for $Ga_{0.8}In_{0.2}N/GaN$ and $Al_{0.8}Ga_{0.2}N/AlN$ QWs. For $Ga_{0.8}In_{0.2}N/GaN$ QWs the 'dead' width for positive material gain starts at ~4 nm and ends at ~8 nm. For $Al_{0.8}Ga_{0.2}N/AlN$ QW this area starts at similar width but is broader.



Fig. 7. Spectra of TM material gain obtained for different carrier concentrations in QW region for (a) 2 nm and (b) 15 nm wide $Al_{0.8}Ga_{0.2}N/GaN$ QWs together with (c) the comparison of the peak intensity of the material gain for the two QWs of different width.



Fig. 8. Gain peak for (a) $Ga_{0.8}In_{0.2}N(d)/GaN$ and (b) $Al_{0.8}Ga_{0.2}N(d)/GaN$ QWs with the width varying in the range of 2-15 nm.

We expect that the 'dead' width will be also present for other polar III-N QWs since the built-in electric field is the driving force for no positive gain in this QW system. As can be seen in Fig. 8, the range of the "dead" width depends on the QW composition, which affects the polarization discontinuity (i.e., built-in electric field), the band gap, and the electron (hole) effective mass. A general conclusion regarding the range of 'dead' width for all polar III-N QWs is rather difficult since material parameters can vary very significantly between QWs of different composition. Moreover the comparison of the intensity of material gain for QWs of different width at the same average carrier concentration in the QW region can be insufficient for the direct extrapolation our conclusions to LDs, but the conclusion on "dead" width is still valid. It is rather obvious that narrow QWs (d < 4 nm) will be a good gain medium and also a good gain medium will be wide QWs (d > 10 nm).

In the context of studies reported in this work, the engineering of QW width in broad range can be also very interesting for staggered polar GaInN/GaN and AIGaN/AIN QWs. So far, large widths were not considered for staggered QWs as a drastic decrease in gain with increasing QW width was observed [59]. Since this polar QW system is non-intuitive, considering large widths in staggered QWs can lead to unexpected results, as shown in this paper for rectangular QWs.

III. CONCLUSION

In this work the material gain is calculated for $Ga_{0.8}In_{0.2}N/GaN$ and $Al_{0.8}Ga_{0.2}N/AlN$ QWs with the width varying in the range of 2-15 nm. We observed that the material gain for these QWs drops to zero with the increase in the QW width and reaches negative values in the width range of ~4-8 nm even for high carrier concentrations, but after exceeding a certain width to 8-12 nm it begins to increase rapidly and reaches the values greater than those observed for narrow wells. This phenomenon is related to the screening of the built-in electric field by carriers, which is easier for wide QWs, and the reduction of the distance between the energy levels for electrons and holes. For the latter reason, optical transitions between higher energy states make a very significant contribution to the positive material gain.

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